



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**PCN# 20150316000
Datasheet update for ADS1282
Information Only**

Date: 3/19/2015
To: MOUSER PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this PCN are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services

20150316000
Information Only Datasheet
Attachments


Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE
ADS1282IPW

CUSTOMER PART NUMBER
null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20150316000		PCN Date:	03/19/2015
Title:	Datasheet update for ADS1282			
Customer Contact:	PCN Manager	Dept:	Quality Services	
Change Type:				
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site		
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material		
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process		
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site		
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials		
		<input type="checkbox"/> Wafer Fab Process		
PCN Details				
Description of Change:				
Texas Instruments Incorporated is announcing an information only notification.				
The product datasheet(s) is being updated as summarized below.				
The following change history provides further details				
		ADS1282		
www.ti.com		SBAS418I – SEPTEMBER 2007 – REVISED MARCH 2015		
15 Revision History				
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.				
Changes from Revision H (August 2013) to Revision I				Page
• Deleted low-power mode from data sheet, and made high-resolution mode default				1
• Changed MODE bit to 1 in register map after removing mode option				35
• Deleted MODE bit from CONFIG0; changed to 1				36
The datasheet number will be changing.				
Device Family	Change From:	Change To:		
ADS1282	SBAS418H	SBAS418I		
These changes may be reviewed at the datasheet links provided.				
http://www.ti.com/product/ads1282				
Reason for Change:				
To more accurately reflect device characteristics.				
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):				
Electrical specification performance changes as indicated above.				
Changes to product identification resulting from this PCN:				
None.				
Product Affected:				
ADS1282HIPW	ADS1282IPW	ADS1282IPWR		
ADS1282HIPWR	ADS1282IPWG4			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com